

## 2 PIN CID PACKAGE

### Features

- 0.44mm thickness
- Support wide IC dimensions 2.5 x 3.8mm

### Description

The 2 pin CIDPACK is a small, thin package specially designed for contactless identification devices (CID). Its mechanical characteristics make it usable in the same conditions as an industrial package. Point or tin soldering are ideal for electrical connections.

### Applications

- CID devices

### Marking

Full lot tracability is guaranteed with the package marking.

### Delivery

Packages are delivered in antistatic bags with 1000 pieces per bag.

### Quality

Package qualification based on MIL-STD-883 procedures.

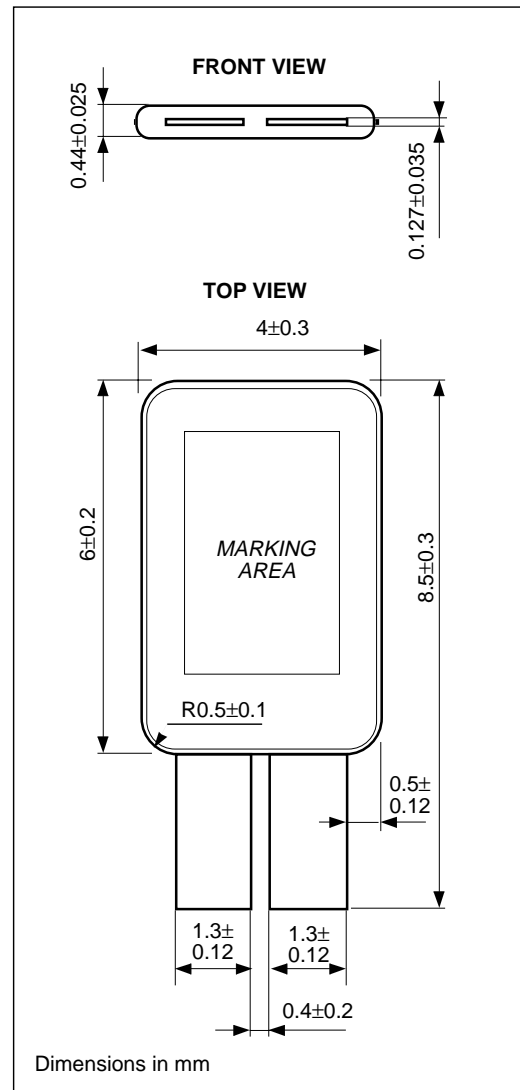
### Storage Temperature

Refer to chip specification. Maximum temperature should not exceed 150°C.

### Material

Molding compound	: Black Epoxy
Back side	: Alloy 42
Pins	: Alloy 42, Silver coated

### Dimensions



The back side is not completely covered by the compound. The metal on this side is electrically connected to the chip substrate. This max. package length and width do not include plastic flash protrusion.